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RG320240A1-BIW-V

CUSTOMER:

SPECIFICATION

APPROVED BY:		
(FOR CUSTOMER USE ONLY)		
	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
ISSUED DATE:		<u> </u>	I

RG320240A1-BIW-V

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1. Specification Revision History

	RECORDS OF REVISION								
VERSION	DATE	REVISED PAGE NO.	Note						
1	2008.03.21		First issue						

2. General Specification

The Features of the Module is description as follow:

■ Module dimension: 160.0 x 109.0 x 11.0 (max.) mm³

■ View area: 122.0 x 92.0 mm²

■ Active area: 115.18 x 86.38 mm²

■ Number of Dots: 320 x2 40

■ Dot size: 0.34 x 0.34 mm²

■ Dot pitch: 0.36 x 0.36 mm²

■ LCD type: STN Negative, Transmissive ,Blue

■ View direction: 6 o'clock

■ Backlight Type: LED White

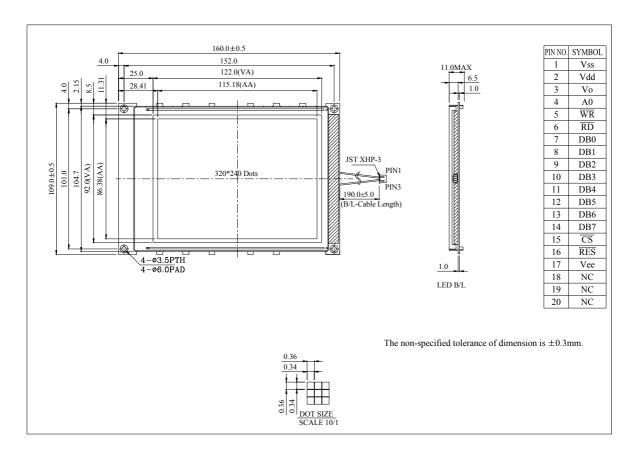
3. Module Classification Information

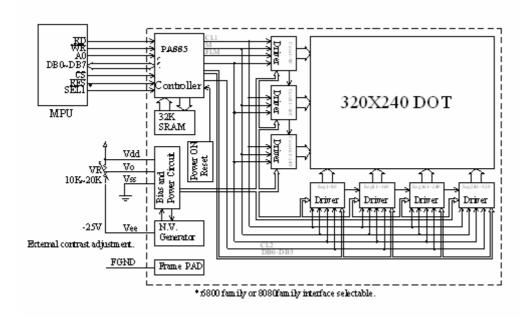
Item		Description	on				
1	Brand: Raystar Optronics Inc.						
2	Display Type	C: Character Type,					
	1 0 01	G: Graphic Type					
3		320 x 240 Dots					
4	Serials Code.						
		P: TN Positive, Gray					
		N: TN Negative,					
		G: STN Positive, Gray					
5	LCD Mode	Y: STN Positive, Yellow Gree	n				
		B: STN Negative, Blue					
		F: FSTN Positive					
		T: FSTN Negative					
		A: Reflective, N.T, 6:00	K: Transflective, W.T,12:00				
		D: Reflective, N.T, 12:00	1: Transflective, U.T,6:00				
	LCD	G: Reflective, W. T, 6:00	4: Transflective, U.T.12:00				
	Polarizer	J: Reflective, W. T, 12:00	C: Transmissive, N.T,6:00				
6	Type/ Temperature	0: Reflective, U. T, 6:00	F: Transmissive, N.T,12:00				
	range/ View	3 : Reflective, U. T, 12:00	I: Transmissive, W. T, 6:00				
	direction	B: Transflective, N.T,6:00	L: Transmissive, W.T,12:00				
		E: Transflective, N.T.12:00	2: Transmissive, U. T, 6:00				
		H: Transflective, W.T,6:00	5: Transmissive, U.T,12:00				
		N: Without backlight	Y: LED, Yellow Green				
	D 11: 1	P: EL, Blue green	A: LED, Amber				
7	Backlight Type	T: EL, Green	W: LED, White				
	Турс	D: EL, White	O: LED, Orange				
		F: CCFL, White	G: LED, Green				
8	Special Code	V: Built-in Negative Voltage					

4. Interface Pin Function

Pin No.	Symbol	Level	Description
1	V_{SS}	0V	Ground
2	$V_{ m DD}$	5.0V	Power supply for Logic
3	V_{O}	(Variable)	Driving voltage for LCD
4	A 0	11/1	RD=L WR=H ,A0=L :Data Read AO=H :Status read
4	A0	H/L	RD=H WR=L ,A0=L :Data Write AO=H :Command write
5	WR	H/L	8080 family: Write signal, 6800 family: R/W signal
6	RD	H/L	8080 family: Read signal, 6800 family: Enable clock
7~14	DB0~DB7	H/L	Data bus
15	CS —	H/L	Chip select ,Active L
16	RES	H/L	Controller reset signal, Active L
17	$ m V_{EE}$	-25V	Negative voltage output (Optional)
18	NC		No connection
19	NC		No connection
20	NC		No connection

5. Outline Dimension & Block Diagram





6. Timing Characteristics

The RA8835 series is controller IC that can display text and graphics on LCD panel. The RA8835 series can display layered text and graphics, scroll the display in any direction and partition the display into multiple screens. The RA8835 series stores text, character codes and bitmapped graphics data in external frame buffer memory. Display controller functions include transferring data from controlling microprocessor to the buffer memory, reading memory data, converting data to display pixels and generating timing signals for the buffer memory, LCD panel. The RA8835 series has internal character generator with 160, 5*7 pixel characters in internal mask ROM. The character generators support up to 64,8*16 pixel characters in external characters in external character generator RAM and up to 256,8*16 pixel characters in external character generator ROM.

The Command Set

Table 1. Command set

Class Command			Code							Hex Command Description		Command Read Parameters				
		RD	WR	A 0	D7	D6	D5	D4	D3	D2	D1	D0			No. of Bytes	Sec- tion
System	SYSTEM SET	1	0	1	0	1	0	0	0	0	0	0	40	Initialize device and display	8	8.2.1
CONTROL	SLEEP IN	1	0	1	0	1	0	1	0	0	1	1	53	Enter standby mode	0	8.2.2
	DISP ON/OFF	1	0	1	0	1	0	1	1	0	0	D	58, 59	Enable and disable dis- play and display flashing	1	8.3.1
	SCROLL	1	0	1	0	1	0	0	0	1	0	0	44	Set display start address and display regions	10	8.3.2
	CSRFORM	1	0	1	0	1	0	1	1	1	0	1	5D	Set cursor type	2	8.3.3
Display	CGRAM ADR	1	0	1	0	1	0	1	1	1	0	0	5C	Set start address of char acter generator RAM	2	8.3.6
control	CSRDIR	1	0	1	0	1	0	0	1	1	CD 1	CD 0	4C to 4F	Set direction of cursor movement	0	8.3.4
	HDOT SCR	1	0	1	0	1	0	1	1	0	1	0	5A	Set horizontal scroll position	1	8.3.7
	OVLAY	1	0	1	0	1	0	1	1	0	1	1	5B	Set display overlay format	1	8.3.5
Drawing	CSRW	1	0	1	0	1	0	0	0	1	1	0	46	Set cursor address	2	8.4.1
control	CSRR	1	0	1	0	1	0	0	0	1	1	1	47	Read cursor address	2	8.4.2
Memory	MWRITE	1	0	1	0	1	0	0	0	0	1	0	42	Write to display memory	_	8.5.1
control	MREAD	1	0	1	0	1	0	Read from display		' '	_	8.5.2				

Notes:

In general, the internal registers of the RA8835 is series are modified as each command parameter is input. However,
the microprocessor does not have to set all the parameters of a command and may send a new command before all parameters
have been input. The internal registers for the parameters that have been input will have been changed but the remaining
parameter registers are unchanged.

2-byte parameters (where two bytes are treated as 1 data item) are handled as follows:

- a. CSRW, CSRR: Each byte is processed individually. The microprocessor may read or write just the low byte of the cursor address.
- SYSTEM SET, SCROLL, CGRAM ADR: Both parameter bytes are processed together. If the command is changed after half of the parameter has been input, the single byte is ignored.
- 2. APL and APH are 2-byte parameters, but are treated as two 1-byte parameters.

SYSTEM SET

Initializes the device, sets the window sizes, and selects the LCD interface format. Since this command sets the basic operating parameters of the RASS35 is series, an incorrect SYSTEM SET command may cause other commands to operate incorrectly.

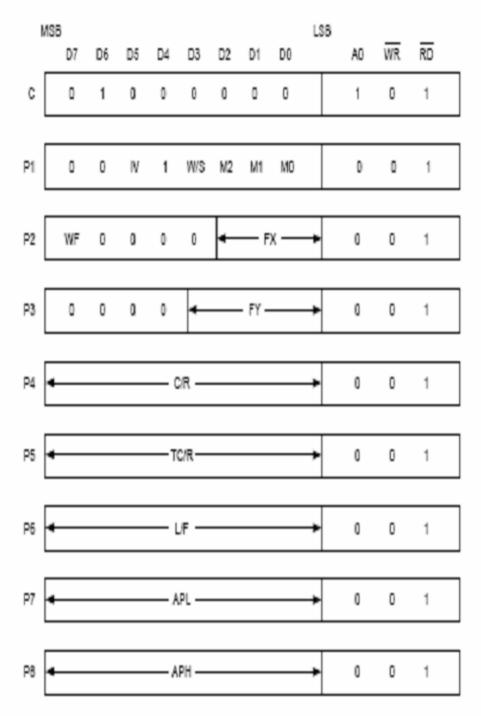


Figure 1. SYSTEM SET instruction

7. Optical Characteristics

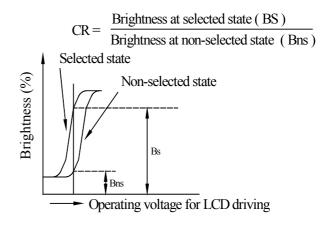
ITEM	SYMBAL	CONDITION	MIN	TYP	MAX	UNIT
	(V) θ	CR≧2	20	_	40	deg.
View Angle	(H) φ	CR≧2	-30	_	30	deg.
Contrast Ratio	CR	_	_	3	_	_
	T rise	_	_	200	300	ms
Response Time	T fall	_	_	150	200	ms

7.1 Definitions

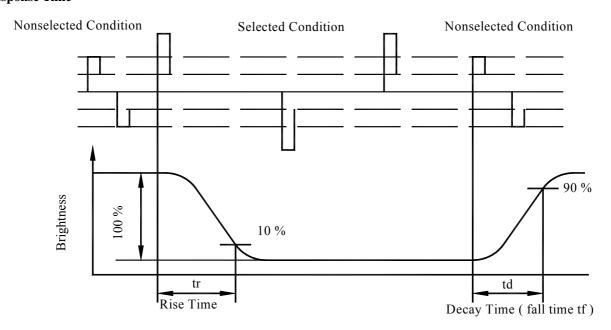
View Angles

Z (Visual angle direction) X_{φ} Y_{θ}

Contrast Ratio



■ Response Time



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8. Absolute Maximum Ratings

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}$ C
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	V _I	0	_	V_{DD}	V
Supply Voltage For Logic	$ m V_{DD}$	0	_	6.5	V
Supply Voltage For LCD	$V_{ m DD}$ - $V_{ m EE}$	0	_	32	V

9. Electrical Characteristics

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Logic Voltage	V_{DD} - V_{SS}	_	4.5	5.0	5.5	V
		Ta=-20°C	_	_	26.5	V
Supply Voltage For	$V_{ m DD}$ - $V_{ m O}$	Ta=25°C	_	24.0	_	V
LCD		Ta=+70°C	22.1	_	_	V
Input High Volt.	V_{IH}	_	$0.5V_{DD}$	_	V_{DD}	V
Input Low Volt.	V_{IL}	_	V_{SS}	_	$0.2V_{\mathrm{DD}}$	V
Output High Volt.	V _{OH}	_	2.4	_	_	V
Output Low Volt.	V _{OL}	_	_	_	0.4	V
Supply Current	I _{DD}	_	95.0	100.0	110.0	mA

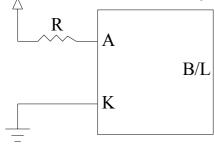
10. Backlight Information

Specification (Ta= 25° C)

peemeation						(14 25 (
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	115.2	128	200	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	_
Reverse Voltage	VR	_	_	5	V	_
Luminous Intensity	IV	260	280	_	CD/M ²	ILED=128mA
Wave Length	λρ			_	nm	ILED=128mA
Life Time	_	_	50K	_	Hr.	ILED≤128mA
Color	White					1

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

LED B\L Drive Method 1.Drive from A, K



11. Reliability

Content of Reliability Test (wide temperature, -20°C~70°C)

	Environmental Test							
Test Item	Content of Test	Test Condition	Note					
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2					
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30℃ 200hrs	1,2					
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	200hrs						
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1					
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60℃,90%RH 96hrs	1,2					
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles						
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 15mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes						
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time						

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.

12. Inspection specification

NO	Item	Criterion				
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 				
02	Black or white spots on LCD (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 				
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type : As following drawing $\Phi = (x + y)/2$ X $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$ 0 3.2 Line type : (As following drawing) $C = A $	2.5			
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	2.5			

NO	Item	Criterion	AQL				
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination					
06	Chipped glass	Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length: 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:	2.5				

NO	Item	Criterion	AQL
NO 06	Item	$\begin{array}{c} \text{Symbols:} \\ \text{x: Chip length} & \text{y: Chip width} & \text{z: Chip thickness} \\ \text{k: Seal width} & \text{t: Glass thickness} & \text{a: LCD side length} \\ \text{L: Electrode pad length} \\ \text{6.2 Protrusion over terminal:} \\ \text{6.2.1 Chip on electrode pad:} \\ \\ \hline y: \text{Chip width} & \text{x: Chip length} & \text{z: Chip thickness} \\ \hline y \leq 0.5 \text{mm} & \text{x} \leq 1/8 \text{a} & 0 < \text{z} \leq \text{t} \\ \hline \text{6.2.2 Non-conductive portion:} \\ \hline \\ \hline y: \text{Chip width} & \text{x: Chip length} & \text{z: Chip thickness} \\ \hline y \leq \text{L} & \text{x} \leq 1/8 \text{a} & 0 < \text{z} \leq \text{t} \\ \hline \text{O If the chipped area touches the ITO terminal, over 2/3 of the ITO} \\ \hline \end{array}$	AQL 2.5
		 ⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. ⊙ If the product will be heat sealed by the customer, the alignment mark not be damaged. 6.2.3 Substrate protuberance and internal crack. y: width x: length y≤1/3L x≤ a 	

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB 	2.5 2.5 0.65 2.5 2.5 0.65 2.5 2.5 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65

NO	Item	Item Criterion	
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 2.5 0.65 0.65 0.65

13. Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.

14. Material List of Components for RoHs

1. RAYSTAR Optronics Co., Ltd. hereby declares that all of or part of products, including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs	
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	
Above limited value is set up according to RoHS.							

2. Process for RoHS requirement:

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°€;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.



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LCM	Sample	Estimate Feedback Sheet	
Module Number :	•		
1 · Panel Specification :			
1. Panel Type:	Pass	□ NG ,	
2. View Direction:	Pass	□ NG ,	
3. Numbers of Dots:	Pass	□ NG,	
4. View Area:	Pass	□ NG ,	
5. Active Area:	Pass	□ NG ,	
6.Operating Temperature:	Pass	□ NG ,	
7.Storage Temperature:	Pass	□ NG ,	
8.Others:			
2 · Mechanical Specification	:		
1. PCB Size:	Pass	□ NG ,	
2.Frame Size:	Pass	□ NG ,	
3.Materal of Frame:	Pass	□ NG ,	
4.Connector Position:	Pass	□ NG ,	
5.Fix Hole Position:	☐ Pass	□ NG,	
6.Backlight Position:	☐ Pass	□ NG ,	
7. Thickness of PCB:	☐ Pass	□ NG ,	
8. Height of Frame to PCB:	☐ Pass	□ NG ,	
9.Height of Module:	☐ Pass	□ NG ,	
10.Others:	☐ Pass	□ NG ,	
3 · Relative Hole Size:			
1.Pitch of Connector:	☐ Pass	□ NG ,	
2.Hole size of Connector:	Pass	□ NG ,	
3. Mounting Hole size:	☐ Pass	□ NG ,	<u> </u>
4.Mounting Hole Type:	☐ Pass	□ NG ,	
5.Others:	☐ Pass	□ NG,	
4 · <u>Backlight Specification</u> :			
1.B/L Type:	☐ Pass	□ NG ,	_
2.B/L Color:	☐ Pass	□ NG ,	_
	ence for LEI	O Type): Pass NG,	
4.B/L Driving Current:	☐ Pass	□ NG ,	
5.Brightness of B/L:	☐ Pass	□ NG ,	
6.B/L Solder Method:	Pass	□ NG ,	_
7.Others:	☐ Pass	□ NG ,	



Page: 2

Module Number :				
5 · Electronic Characteristic	s of Module	<u>;</u> :		
1.Input Voltage:	☐ Pass	□ NG ,		_
2.Supply Current:	☐ Pass	☐ NG ,		_
3.Driving Voltage for LCD:	☐ Pass	☐ NG ,		
4.Contrast for LCD:	☐ Pass	☐ NG ,		
5.B/L Driving Method:	☐ Pass	☐ NG ,		=
6.Negative Voltage Output:	☐ Pass	☐ NG ,		
7.Interface Function:	☐ Pass	☐ NG ,		<u> </u>
8.LCD Uniformity:	☐ Pass	☐ NG ,		_
9.ESD test:	☐ Pass	☐ NG ,		_
10.Others:	☐ Pass	☐ NG ,		
Sales signature:				
Customer Signature :			Date: /	